

Vishay Siliconix

P-Channel 12-V (D-S) MOSFET

| PRODUCT SUMMARY | | | | |
|---------------------|------------------------------------|--------------------|--|--|
| V _{DS} (V) | R_{DS(on)} (Ω) | I _D (A) | | |
| | 0.051 at V _{GS} = - 4.5 V | - 4.0 | | |
| - 12 | 0.070 at V _{GS} = - 2.5 V | - 3.5 | | |
| | 0.106 at V _{GS} = - 1.8 V | - 3.0 | | |

FEATURES

- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET[®] Power MOSFETs: 1.8 V Rated



COMPLIANT HALOGEN FREE Available

TO-236 (SOT-23) G 1 3 D S 2 Top View Si2335DS (E5)* *Marking Code

Ordering Information: Si2335DS-T1-E3 (Lead (Pb)-free) Si2335DS-T1-GE3 (Lead (Pb)-free and Halogen-free)

| Parameter | | Symbol | 5 s | Steady State | Unit |
|--|------------------------|-----------------------------------|-------------|--------------|------|
| Drain-Source Voltage | | V _{DS} | - 12 | | V |
| Gate-Source Voltage | | V _{GS} | ± 8 | | |
| Continuous Drain Quarterst (T. 150 °C)a b | T _A = 25 °C | – I _D | - 4.0 | - 3.2 | ٨ |
| Continuous Drain Current (T _J = 150 °C) ^{a, b} | T _A = 70 °C | | - 3.3 | - 2.6 | |
| Pulsed Drain Current | | I _{DM} | - 15 | | A |
| Continuous Source Current (Diode Conduction) ^{a, b} | | ۱ _S | - 1.6 | | |
| n | T _A = 25 °C | – P _D | 1.25 | 0.75 | W |
| Maximum Power Dissipation ^{a, b} | T _A = 70 °C | | 0.8 | 0.48 | vv |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | - 55 to 150 | | °C |

| THERMAL RESISTANCE RATINGS | | | | | |
|--|--------------|-------------------|---------|---------|------|
| Parameter | | Symbol | Typical | Maximum | Unit |
| | t ≤ 5 s | R _{thJA} | 75 | 100 | |
| Maximum Junction-to-Ambient ^a | Steady State | | 120 | 166 | °C/W |
| Maximum Junction-to-Foot (Drain) | Steady State | R _{thJF} | 40 | 50 | |

Notes:

a. Surface mounted on 1" x 1" FR4 board.
b. Pulse width limited by maximum junction temperature.

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| SPECIFICATIONS $T_J = 25$ | 5 °C, unless | otherwise noted | | | | | |
|---|---------------------|---|-------------------------|-------|-------|------|--|
| Parameter | | | Limits | | | | |
| | Symbol | Test Conditions | Min. | Тур. | Max. | Unit | |
| Static | | | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | V_{GS} = 0 V, I _D = - 10 µA | - 12 | | | V | |
| Gate-Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$ | - 0.45 | | | | |
| Gate-Body Leakage | I _{GSS} | $V_{DS} = 0 V, V_{GS} = \pm 8 V$ | | | ± 100 | nA | |
| Zero Gate Voltage Drain Current | I _{DSS} | $V_{DS} = -9.6 V, V_{GS} = 0 V$ | , V _{GS} = 0 V | | - 1 | | |
| | | V_{DS} = - 9.6 V, V_{GS} = 0 V, T_{J} = 55 °C | | | - 10 | μA | |
| On-State Drain Current ^a | | $V_{DS} \leq$ - 5 V, V_{GS} = - 4.5 V | - 15 | | | | |
| | I _{D(on)} | $V_{DS} \leq$ - 5 V, V_{GS} = - 2.5 V | - 6 | | | A | |
| | | V _{GS} = - 4.5 V, I _D = - 4.0 A | | 0.042 | 0.051 | Ω | |
| Drain-Source On-Resistance ^a | R _{DS(on)} | $V_{GS} = -2.5 \text{ V}, \text{ I}_{D} = -3.5 \text{ A}$ | | 0.058 | 0.070 | | |
| | | V _{GS} = - 1.8 V, I _D = - 2.0 A | | 0.082 | 0.106 | | |
| Forward Transconductance ^a | 9 _{fs} | $V_{DS} = -5 V, I_{D} = -4.0 A$ | | 7 | | S | |
| Diode Forward Voltage | V _{SD} | I _S = - 1.6 A, V _{GS} = 0 V | | | - 1.2 | V | |
| Dynamic ^b | | | | | | | |
| Total Gate Charge | Qg | | | 9 | 15 | nC | |
| Gate-Source Charge | Q _{gs} | V_{DS} = - 6 V, V_{GS} = - 4.5 V, I_D \cong - 4.0 A | | 1.9 | | | |
| Gate-Drain Charge | Q _{gd} | | | 1.5 | | 1 | |
| Input Capacitance | C _{iss} | | | 1225 | | pF | |
| Output Capacitance | C _{oss} | V_{DS} = - 6 V, V_{GS} = 0 V, f = 1 MHz | | 260 | | | |
| Reverse Transfer Capacitance | C _{rss} | | | 130 | | | |
| Switching ^c | | | | | | | |
| Turn-On Time | t _{d(on)} | | | 13.0 | 20 | | |
| | t _r | V_{DD} = - 6 V, R_L = 6 Ω | | 15 | 25 | nc | |
| Turn-Off Time | t _{d(off)} | $\text{I}_\text{D}\cong$ - 1.0 A, V_GEN = - 4.5 V, R_G = 6 Ω | | 50 | 70 | ns | |
| | t _f | | | 19 | 35 | | |

Notes:

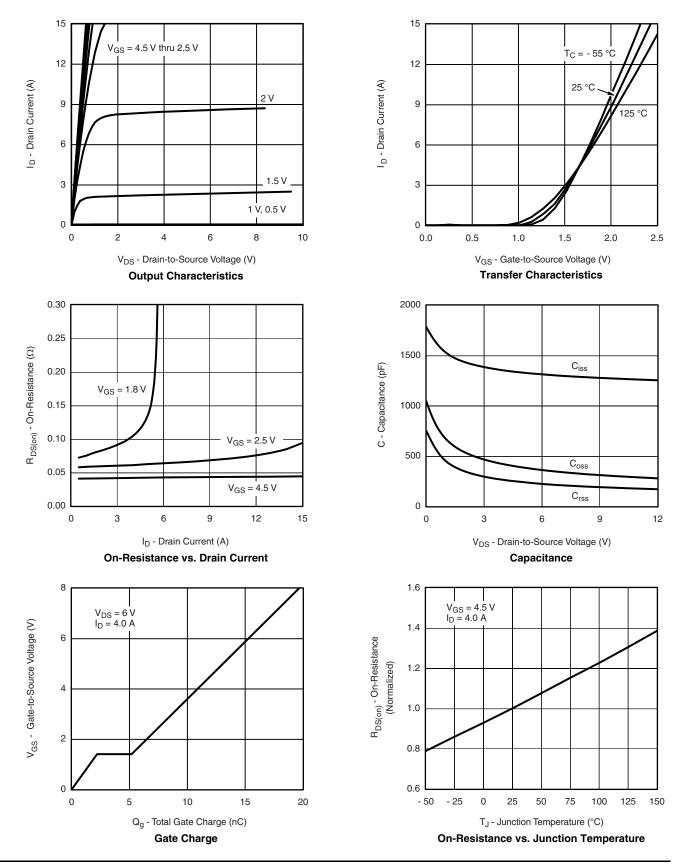
a. Pulse test: PW \leq 300 µs, duty cycle \leq 2 %. b. For design aid only, not subject to production testing. c. Switching time is essentially independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



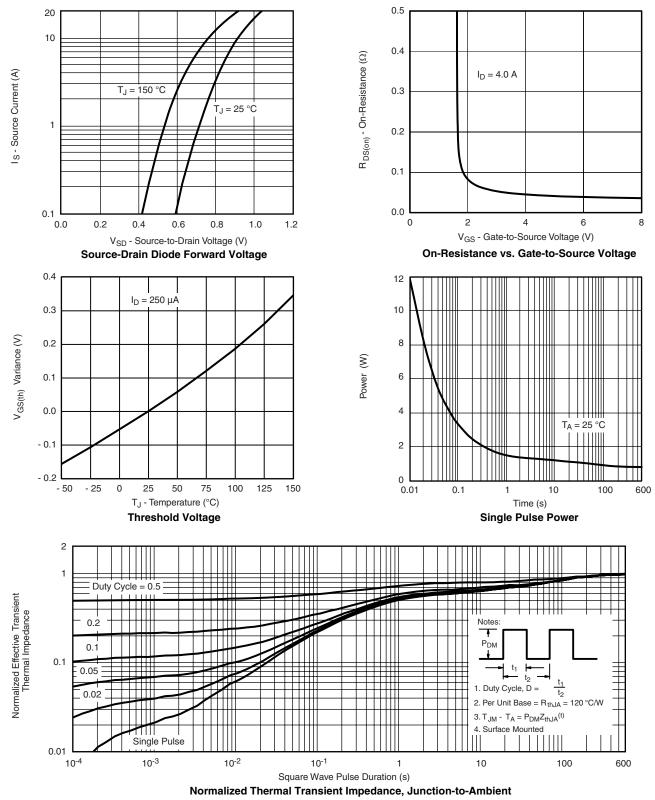
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



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